

Passive Components – TAS Road Map - Summary

- Common requirements for passive parts
- Chip Passive components
- Custom Passive components
- RF Passive components
- Connectors



Passive Components – TAS Road Map

- Common requirements for passive parts
 - Main requirements coming from Equipment & payload road map
 - Equipment/ payload/ design flexibility
 - Higher density & integrated solutions
 - Increase of dissipated power & operating temperature
 - Cost & lead time reductions
 - To promote collaboration with European Suppliers



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Passive Components – TAS Road Map

Chip Passive components :

- Resistors
- Ceramic Capacitors
- Other Capacitors
- High current Fuses

Global requirements

- To improve accuracy (1% or 0.1%) on some dedicated components packages
- Higher admissible voltage and current

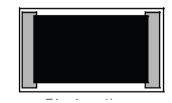


Passive Components – TAS Road Map – Chip passive components

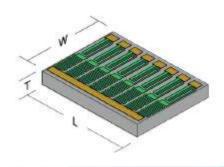
- Chips resistors : preferred
 - ~ R0805
 - To extend resistors family with 0.1% tolerance
 - Higher Voltage for pulse operating condition up to 100 Volts



- Widely used on equipment
- To find qualified European solution
- Package 2512 power at least 1W
- Resistors Networks
 - Extend Sources for resistors networks
 - => Actual lead time of 6 months becomes a real constraint

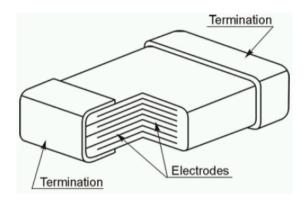








- Ceramic capacitors
 - MLCC type 1
 - To expand Low values capacitors (<1nF) with better accuracy: 1%</p>
 - To get High voltage Capacitors : > +200V to +400V
 - MLCC type 2
 - To expand value range in low voltage : < +10V</p>
 - To get high value (µF) with low ESR
 - To improve mechanical withstanding for Both types



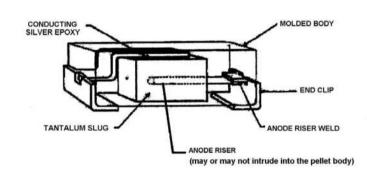
- => High values replaced by film capacitors -> good C/V rate
- => Replacement of solid tantalum capacitors by low voltage values for high temperature applications





Film plastic

- No anomaly recorded in short circuit
 - To expand the range of low values
 - ∠ To reduce size case : 25%
- Solid tantalum
 - High values with low ESR
 - To expand the range of low voltage values : < 10V</p>
 - → To get Ultra low ESR
 - Low jam in multi-anodes
- Polymer tantalum
 - No short circuit in failure mode & Limited derating
 - Need similar to Solid tantalum



High current Fuse

NO European supplier qualified for high current fuses, majoritary US products are available on space market.

~ Products

Quick acting fuse from European supplier



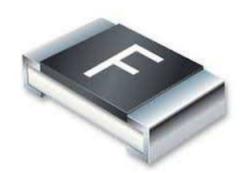
Full CMS report

Rated Current : 5, 10, 15, 20 Amp

Operating Voltage: 150 V

Low sensitivity to Pulsed current applications

Operating temperature range : - 55℃ to + 125℃



Passive Components – TAS Road Map

- Common requirements for passive parts
- Chip Passive components
- Custom Passive components
- RF Passive components
- Connectors



Custom Passive components :

- Crystals
- Oscillators
- Magnetics
- Miniature EMI filters Feedthrough

Global requirements

- To get custom & flexible electrical performances with standard solutions (package and technology)
- To develop hybrid integrated solutions
- To improve lead time



Crystal

Key component to achieve great performances on telecom satellite receivers. Improve lead time delivery and phase noise behavior.

Products:

- 50 to 100 Mhz, T807 or SMC Crystal Resonator
- Key performances
 - Available in SC, AT,...cut
 - High long terme stability: < 1ppm /20 years</p>
 - Low noise arround F0 between 10 Hz & 1 KHz
 - Rated power 500 μ watt
 - > Low lead time



=> Hybrid Crystal (Crystal, thermistors, resistors...)

Oscillateur XO

Clock reference for numeric board, No european qualified supplier for these products

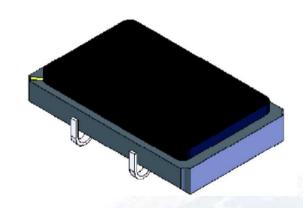
~Product:

10 to 100 Mhz, FP 16 low size or automatic SMC Xtal Oscillator

Key performances

- Global frequency Stability: +/- 70 ppm
- Aging : +/- 15 ppm
- Supply Voltage: 3,3 V preferred (low consumption)
- AHCMOS Compatible
- Low lead time and similar cost Vs US supplier







Passive Components – TAS Road Map – Custom passive components

Magnetics

- For the next power supply generation, 3 key technological improvements are required. No state of the art solutions qualified for space applications.
- Product:
 - Power & current transformers, filtering self...
 - Key performances
- 1. To improve reproductiveness of electrical performances (Toroid, RM Core...)
 - Same cost
 - Improvement of winding processes (leakage inductor reproducible and low...)
- 2. To find integrated solutions: size reduction of -20%
 - SMD packages
 - Planar solutions







Passive Components – TAS Road Map – Custom passive components

- 3. To find materials with optimized Magnetic Flux Saturation limit (Bsat) at upper temperature (increase of global temperature + 20℃)
- To increase dissipated powers at equipment level
- Compliance to TAS industrial process

Additional requirement from specific equipments: Wide Band RF Transformer solutions

Band: 100MHz to 3GHz

Impedance ratio : 1:2

I/O impedance : 50/100Ohms

Max input Power: +30dBm

Reproducible performances and low cost



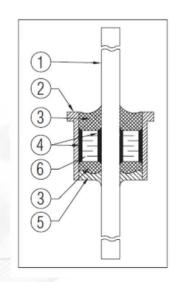
Passive Components – TAS Road Map – Custom passive components

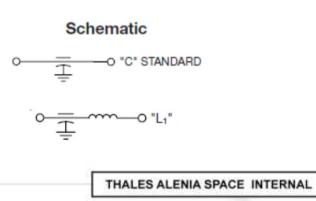
- Miniature EMI filters Feedthrough (solder-in & screw-in)
 - Dimensional constraints at equipment level
 - Objective : Housing miniaturization

Focal point: the feedthrough size

→ size reduction : 2mm diameter versus actual 4mm diameter

- Expected benefits :
 - A significant gain in term of mass and size of the new generation of LNA.







Passive Components – TAS Road Map

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- Custom Passive components
- **RF Passive components**
- Connectors



RF Passive components

- Low power Ka band coaxial Isolators/Circulators
- High power coaxial Isolators (L, S and C band)
- Surface mount Isolators (X and Ku band)
- Q & V band Waveguide isolators
- KA Band power Dividers & Couplers
- SMA & SMA 2.9 Attenuators

Global requirements

- Designed to be glitch free.
- Designed to achieve a shielding effectiveness equal or greater than 75dBi for low power devices / 65dBi for high power devices.



- Low power Ka band coaxial Isolators/Circulators
 - ➤ Increase of frequency at payload/equipment level → up to 32GHz
 - No European manufacturer space qualified for Ka band coaxial Isolators/Circulators
 - → Potential risk to procure parts under ITAR restriction
 - Expected Key performances

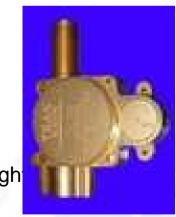
Return loss (VSWR) : 23dB

> Isolation : 23dB

Insertion loss : < 0.5dB</p>



- High power coaxial Isolators (L, S and C band)
 - Increase of RF power at equipment level (SSPA)
 - in the short term
 - → up to 150W (L&S band bandwidth : 100MHz)
 - in the mid term
 - → up to 120W (C band bandwidth : 300MHz and 500MHz)
 - Key performances
 - Return loss and isolation: 23dB
 - Insertion loss : < 0.15dB</p>
 - Other requirements
 - Use of high power connectors with venting holes. Reduced weigh

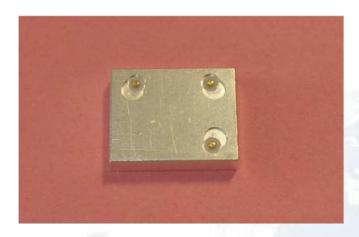




- Surface mount Isolators / Circulators (X & Ku band)
 - ➤ Dimensional constraints at equipment level (thickness) → integrated solutions
 - Expected benefits :
 - A better integration of the Isolators / Circulators on RF boards.
 - A significant gain in term of mass and size of the equipments.
 - Key performances :

Return loss and isolation: 20dB

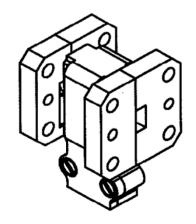
Insertion loss : < 0.25dB</pre>





Passive Components – TAS Road Map – RF Passive components

- Q & V band Waveguide isolators
 - ➤ Dimensional constraints at equipment level → integrated solutions
 - Increase of frequency at payload/equipment level → from 40GHz to 52GHz
 - Expected benefits :
 - A low insertion loss performance with regard to the very high frequency.
 - An integrated solution : waveguide size WR19.
 - Key performances :
 - Return loss and isolation: 20dB
 - Insertion loss : < 0.3dB</p>





KA Band power Dividers & Couplers:

Increase of frequency on the payload input section → up to 32GHz.

- Products:
 - 4 ways, 3 dB Hybride couplers
 - 3 ways , 6, 10 & 20 dB Directional couplers
 - 2, 4, 6 & 8 ways Low power dividers
- Key performances
 - Return loss (VSWR): 22 dB (1.15) typical
 - Low insertion loss variation on operating freq. Range : +/- 0.1 dB
 - Low insertion loss variation on operating temp. Range: +/- 0.1 dB
 - Glitch free, No insertion loss jump on thermal cycling: < 0.05 dB</p>

=> Hybrid solutions with integrated Isolator



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SMA & SMA 2.9 Attenuators

- RF hardness global performances and reliability improvement
- Products:
 - ≥ 0 30 dB, DC 22 Ghz Coaxial SMA attenuator
 - ≥ 0 30 dB, 18 32 Ghz Coaxial SMA 2.9 attenuator



Key performances

- Ruggedized mechanical design
- Return loss (VSWR): 22 dB (1.15) typical
- Low insertion loss variation on operating freq. Range : +/- 0.1 dB
- Glitch free, No insertion loss jump on thermal cycling: < 0.05 dB</p>

=> Fast Locking Coaxial Attenuator







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Passive Components - TAS Road Map

Connectors:

- Interposer Connectors
- High Data Rate Connectors
- SMA 2.4 Connectors
- High power Connectors
- Fast locking Connectors

Global requirements

- High density solutions
- Solderless and competitive solutions
- Fast plugging solutions



Interposer Connectors :

- Integrated solutions for Board to board / Hybrid to board connection (up to 48 contacts)
 - Dimensional constraints at equipment level (thickness).
 - Expected benefits: significant cost reductions (solderless connectors). Higher flexibility during assembly phase. Easy to repair at unit level if needed.
- The interposer connector type RXA is ESA qualified but TAS is looking for a wide range of configuration options (flexible solution) based on the **RXA** design
 - → Thickness, pitch and overall dimensions.
- ⇒ Interposer connectors for RF applications (up to 20GHz)





06/09/2013

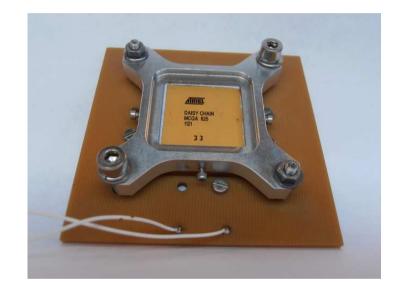
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- Integrated solutions for Board to Component connection
- Key performances

High density: 2000 contacts

Pitch: 0.8mm

- Good heating dissipation
- Good alignment of the assembly
 (PCB footprint interposer component)
- Small size low cost



Other need for interface equipment connections based on solderless solutions → Solderless D-Sub connectors.



High Data Rate Connectors (End to End solution)

Increase flow of digital data between board to board & Unit to unit. High density and important number of connections is required.

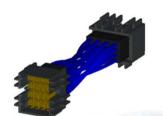
Products:

- Up to 48 high density contacts, mother & daughter board connectors
- Module of 4 coaxial or twinax links, unit & cable connectors



- Solderless, Flexible & Modular solution
- High density, pitch/contact: 3 mm
- Digital Speed : 6.25 Gbit/s.
- Mixed Signal: High speed + Power + DC signal modules

=> Optical Module for Ultra high speed solutions





SMA 2.4 Connectors

- Increase of space operating frequency up to 50 Ghz for dual use broadband payload.
- Products
 - Thread-IN & Four Hole Flange, SMA 2.4 Female connector
- Key performances
 - For glass seal
 - Return loss (VSWR): 22 dB (1.15) typical
 - Low RF leakage : <- 90 dB</p>
 - Wide operating temperature range : 55℃ to + 165℃
- => END to END solution, Unit connectors & Coaxial cables
- => Shall be expand up to 65 Ghz, with SMA 1.85 connectors





Ref.:

High power Connectors

Increase of power at payload level, development of SSPA & OMUX high power solution up to C band.

~ Products:

Four Hole Flange, venting holes, TNC Female connector

Key performances

- CW power : 250 W
- Low sensibility of Multipactor & Corona
- Return loss (VSWR): 25 dB (1.12) typical
- Wide operating temperature range : 55℃ to + 165℃



=> END to END solution, Unit connector & Coaxial cable



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Fast locking Connectors

Increase of unit density on telecom payload integration with a size reduction of 20 % on unit.

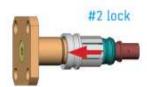
Products

- Thread-IN, 2 or 4 Hole Flange, Fast locking Female connector
- Male connector for multi-size coaxial cable

Key performances

- Smaller than 30% of SMA & High density
- Robust Locking 450 N , 3 second to connect & disconnect
- Return loss (VSWR): 22 dB (1.15) typical
- Z Low RF leakage : < 90 dB at 22 Ghz</p>





- => END to END solution, Unit connectors & Coaxial cables
- => Should be expanded up to 32 Ghz for KA band



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Thanks For Your Attention

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